

AUIRF7805Q

Features

- Advanced Planar Technology
- Low On-Resistance
- Logic Level
- N Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- 150°C Operating Temperature
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, these HEXFET® Power MOSFET's in a Dual SO-8 package utilize the lastest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of these Automotive qualified HEXFET Power MOSFET's are a 150°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These benefits combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

The efficient SO-8 package provides enhanced thermal characteristics and dual MOSFET die capability making it ideal in a variety of power applications. This dual, surface mount SO-8 can dramatically reduce board space and is also available in Tape & Reel.

S III - 8 III D	V _{DSS}	30V
S	R _{DS(on)} typ.	9.2mΩ
	max.	11mΩ
Top View	I _D	13A



G	D	S
Gate	Drain	Source

Bass part number	part number Package Type			Ordershie Part Number	
Base part number	Package Type	Form	Quantity	Orderable Part Number	
AUIRF7805Q	SO-8	Tape and Reel	4000	AUIRF7805QTR	

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

Symbol	Parameter	Max.	Units	
V _{DS}	Drain-Source Voltage	30	V	
V _{GS}	Gate-to-Source Voltage	± 12		
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	13		
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	10	A	
I _{DM}	Pulsed Drain Current ①	100		
P _D @T _A = 25°C	Maximum Power Dissipation ③	2.5	\A/	
P _D @T _A = 70°C	Maximum Power Dissipation ③	1.6	- W	
	Linear Derating Factor	0.02	W/°C	
TJ	Operating Junction and	-55 to + 150	°C	
T _{STG}	Storage Temperature Range		C	

Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
$R_{ ext{ heta}JL}$	Junction-to-Drain Lead®		20	°C/W
$R_{ heta JA}$	Junction-to-Ambient 3		50	C/W

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*Qualification standards can be found at <u>www.infineon.com</u>



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Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	30			V	V _{GS} = 0V, I _D = 250µA
R _{DS(on)}	Static Drain-to-Source On-Resistance		9.2	11	mΩ	V _{GS} = 4.5V, I _D = 7.0A ②
V _{GS(th)}	Gate Threshold Voltage 6	1.0		3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
				70		V _{DS} = 30V, V _{GS} = 0V
I _{DSS}	Drain-to-Source Leakage Current			10	μA	$V_{DS} = 24V, V_{GS} = 0V$
				150		$V_{DS} = 24V, V_{GS} = 0V, T_{J} = 100^{\circ}C$
1	Gate-to-Source Forward Leakage			100	54	V _{GS} = 12V
I _{GSS}	Gate-to-Source Reverse Leakage			-100		V _{GS} = -12V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

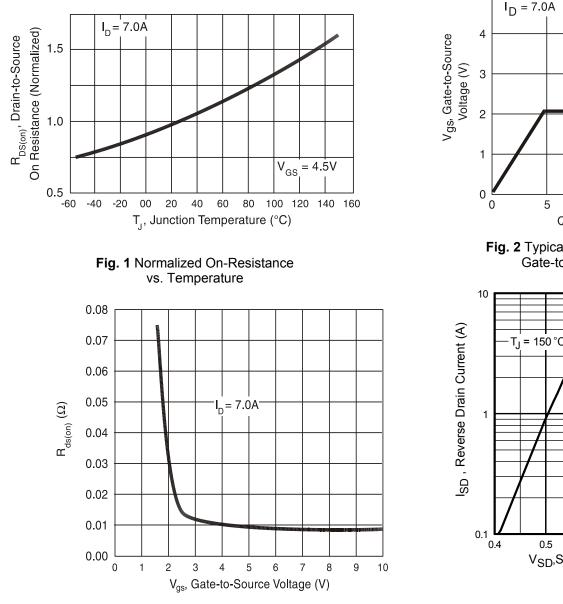
•	C		•			
Q _g	Total Gate Charge		22	31		I _D = 7.0A
Q _{gs1}	Pre -Vth Gate-to-Source Charge		3.7	_		V _{DS} = 16V
Q _{gs2}	Post-Vth Gate-to-Source Charge		1.4		nC	V _{GS} = 5.0V
Q_{gd}	Gate-to-Drain Charge		6.8			
Q _{sw}	Switch Charge (Qgs2 + Qgd)		8.2	11.5		
Q _{oss}	Output Charge		3.0	3.6	nC	V _{DS} = 16V, V _{GS} = 0V
R _G	Gate Resistance	0.5		1.7	Ω	
t _{d(on)}	Turn-On Delay Time		16			V _{DD} = 16V,V _{GS} = 4.5V ②
t _r	Rise Time		20		ns	I _D = 7.0A
t _{d(off)}	Turn-Off Delay Time		38		115	$R_{G} = 2\Omega$
t _f	Fall Time		16			Resistive Load
Diode Chara	Diode Characteristics					
	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)			2.5		MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①			106		integral reverse p-n junction diode.
V _{SD}	Diode Forward Voltage®			1.2	V	$T_J = 25^{\circ}C, I_S = 7.0A, V_{GS} = 0V$
Q _{rr}	Reverse Recovery Charge ④		88			di/dt = 700A/µs V _{DS} =16V, V _{GS} = 0V, I _S = 7.0A
Q _{rr}	Reverse Recovery Charge ④		55		nC	di/dt = 700A/µs (with 10BQ040) V _{DS} =16V, V _{GS} = 0V, I _S = 7.0A

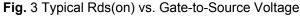
Notes:

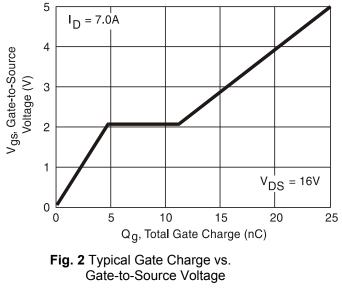
- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width \leq 300µs; duty cycle \leq 2%.
- ③ When mounted on 1" in square copper board, t < 10 sec.
- (4) Typ = measured Q_{OSS}
- $\label{eq:R_theta}$ R_{θ} is measured at T_J of approximately 90°C.
- [©] Devices are 100% tested to these parameters.



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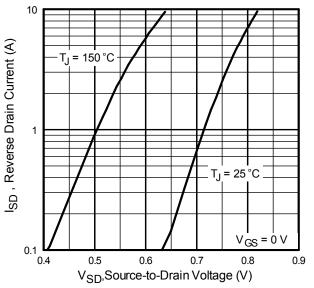


Fig. 4 Typical Source-Drain Diode Forward Voltage

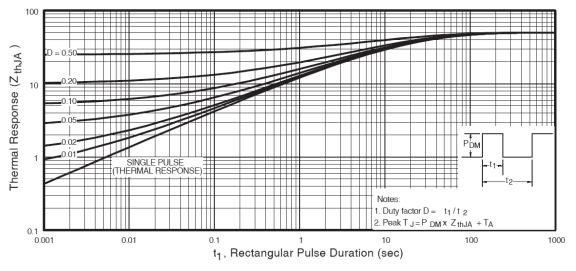
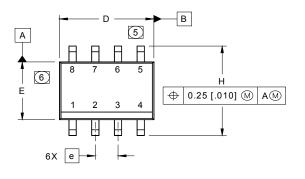
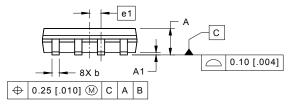


Fig 5. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

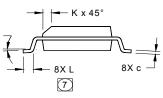


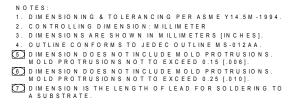
SO-8 Package Outline (Dimensions are shown in millimeters (inches)

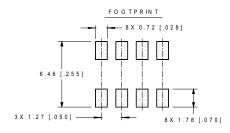




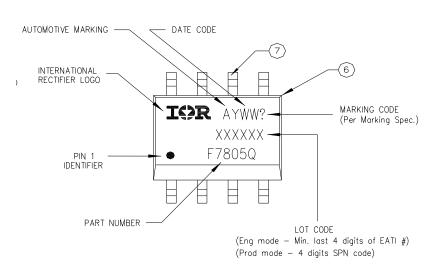
DIM	INC	HES	MILLIM	ETERS	
DIN	MIN	MAX	MIN	MAX	
Α	.0532	.0688	1.35	1.75	
A1	.0040	.0098	0.10	0.25	
b	.013	.020	0.33	0.51	
С	.0075	.0098	0.19	0.25	
D	.189	.1968	4.80	5.00	
E	.1497	.1574	3.80	4.00	
е	.050 BASIC		1.27 BASIC		
e 1	.025 B/	ASIC	0.635 E	BASIC	
Н	.2284	.2440	5.80	6.20	
K	.0099	.0196	0.25	0.50	
L	.016	.050	0.40	1.27	
у	0°	8°	0°	8°	







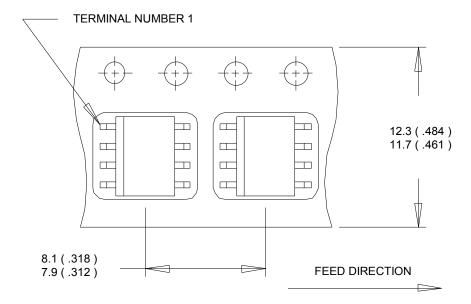
SO-8 Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

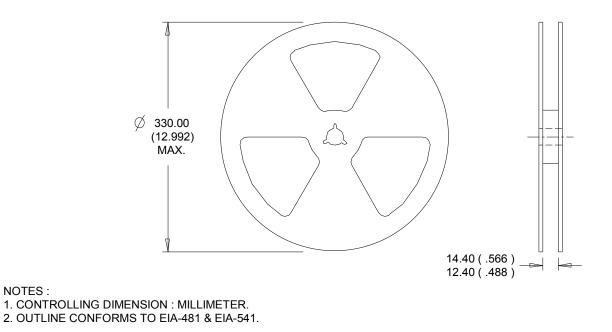


SO-8 Tape and Reel (Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Qualification Information

			Automotive (per AEC-Q101)		
		Comments: This part number(s) passed Automotive qualification. Infineon's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture	Moisture Sensitivity Level SO-8 MSL1				
			Class M3 (+/- 300V) [†]		
	Machine Model		AEC-Q101-002		
505	Liver an Dady Madal	Class H1B (+/- 1000V) [†]			
ESD	Human Body Model	AEC-Q101-001			
		Class C5 (+/- 2000V) [†]			
	Charged Device Model	AEC-Q101-005			
RoHS Cor	npliant	Yes			

+ Highest passing voltage.

Revision History

Date	Comments		
10/5/2015	Updated datasheet with corporate template		
10/3/2013	Corrected ordering table on page 1.		

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